

<b>Notice of References Cited</b>	Application/Control No. 10/724,603	Applicant(s)/Patent Under Reexamination SAITO ET AL.	
	Examiner David E. Graybill	Art Unit 2822	Page 1 of 1

**U.S. PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-5,920,458 A	07-1999	Azar, Kaveh	361/704
	B	US-6,171,691 B1	01-2001	Nishibayashi, Yoshiki	428/325
	C	US-6,211,463 B1	04-2001	Fabis, Philip M.	174/52.5
	D	US-6,270,848 B1	08-2001	Nishibayashi, Yoshiki	427/402
	E	US-6,703,707 B1	03-2004	Mamitsu et al.	257/718
	F	US-6,727,117 B1	04-2004	McCoy, John Washington	438/106
	G	US-6,758,263 B2	07-2004	Krassowski et al.	165/185
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

**FOREIGN PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

**NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Copper-diamond composite substrates for electronic components□□Davidson, H.L.; Colella, N.J.; Kerns, J.A.; Makowiecki, D.;□□Electronic Components and Technology Conference, 1995. Proceedings., 45th□□21-24 May 1995 Page(s):538 - 541
	V	
	W	
	X	

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.